

Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from, Europe, America and south Asia, supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of "Quality Parts, Customers Priority, Honest Operation, and Considerate Service", our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip, ALPS, ROHM, Xilinx, Pulse, ON, Everlight and Freescale. Main products comprise IC, Modules, Potentiometer, IC Socket, Relay, Connector. Our parts cover such applications as commercial, industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



Contact us

Tel: +86-755-8981 8866 Fax: +86-755-8427 6832

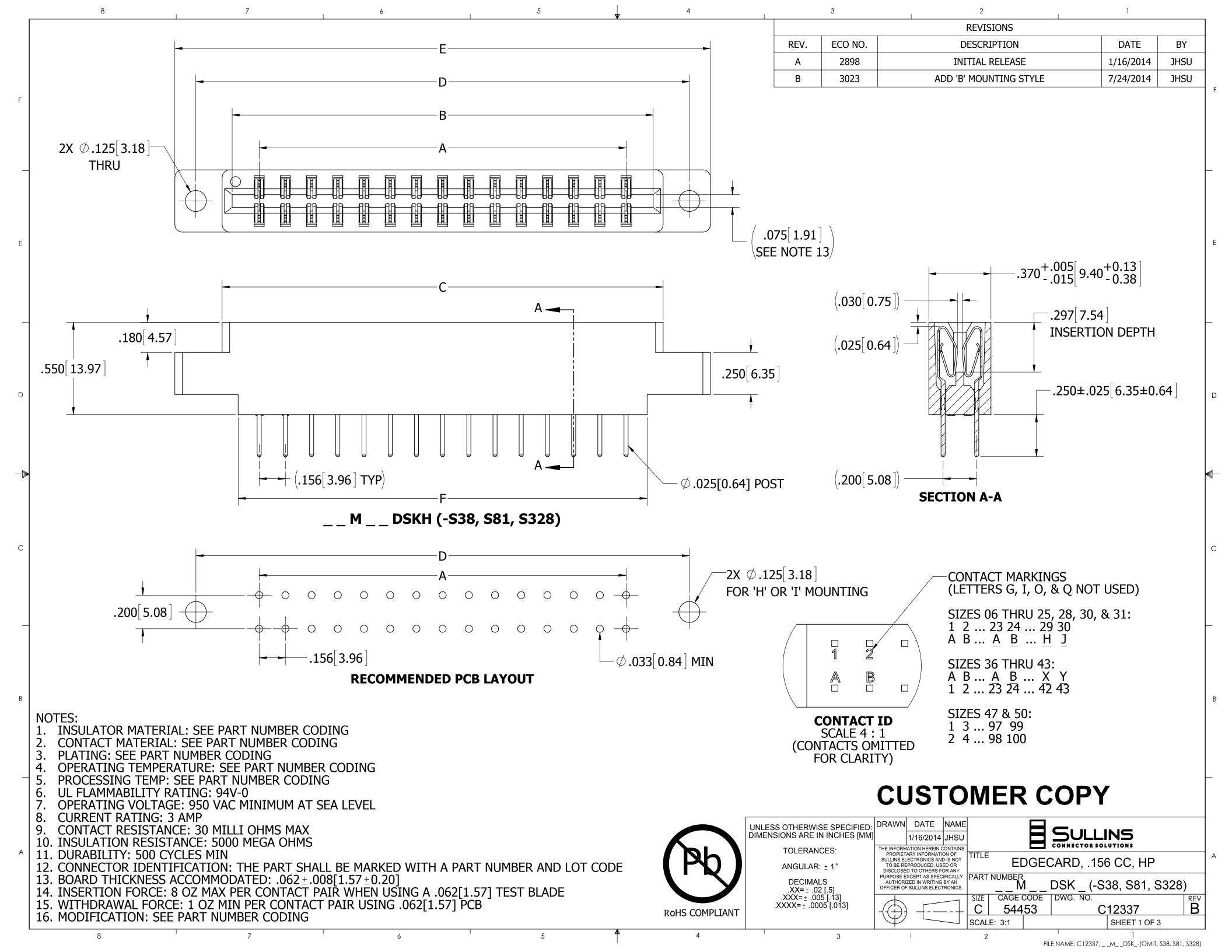
Email & Skype: info@chipsmall.com Web: www.chipsmall.com

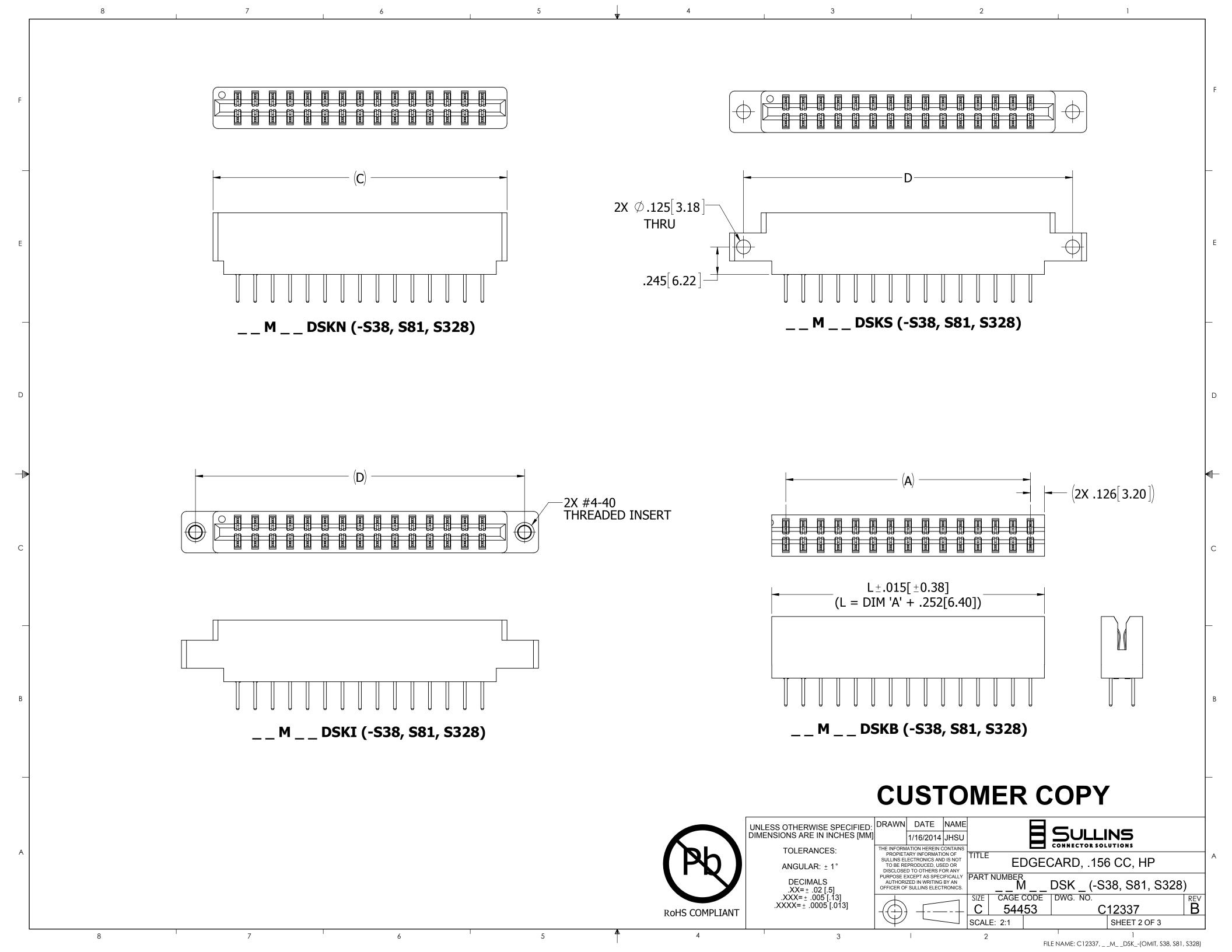
Address: A1208, Overseas Decoration Building, #122 Zhenhua RD., Futian, Shenzhen, China











PART NUMBER	NO. OF POS.	DIMENSIONS											
		A±.008[0.20]		B±.008[0.20]		C±.015[0.38]		D±.010[0.38]		E±.020[0.51]		F±.015[0.38]	
		IN	MM										
M06DSK_	6	0.780	19.81	1.102	27.99	1.221	31.01	1.534	38.96	1.784	45.31	1.030	26.16
M08DSK_	8	1.092	27.74	1.414	35.92	1.533	38.94	1.846	46.89	2.096	53.24	1.342	34.09
M10DSK_	10	1.404	35.66	1.726	43.84	1.845	46.86	2.158	54.81	2.408	61.16	1.654	42.01
M12DSK_	12	1.716	43.59	2.038	51.77	2.157	54.79	2.470	62.74	2.720	69.09	1.966	49.94
M15DSK_	15	2.184	55.47	2.506	63.65	2.625	66.68	2.938	74.63	3.188	80.98	2.434	61.82
M18DSK_	18	2.652	67.36	2.974	75.54	3.093	78.56	3.406	86.51	3.656	92.86	2.902	73.71
M20DSK_	20	2.964	75.29	3.286	83.46	3.405	86.49	3.718	94.44	3.968	100.79	3.214	81.64
M22DSK_	22	3.276	83.21	3.598	91.39	3.717	94.41	4.030	102.36	4.280	108.71	3.526	89.56
M24DSK_	24	3.588	91.14	3.910	99.31	4.029	102.34	4.342	110.29	4.592	116.64	3.838	97.49
M25DSK_	25	3.744	95.10	4.066	103.28	4.185	106.30	4.498	114.25	4.748	120.60	3.994	101.45
M28DSK_	28	4.212	106.98	4.534	115.16	4.653	118.19	4.966	126.14	5.216	132.49	4.462	113.33
M30DSK_	30	4.524	114.91	4.846	123.09	4.965	126.11	5.278	134.06	5.528	140.41	4.774	121.26
M31DSK_	31	4.680	118.87	5.002	127.05	5.121	130.07	5.434	138.02	5.684	144.37	4.930	125.22
M36DSK_	36	5.460	138.68	5.782	146.86	5.901	149.89	6.214	157.84	6.464	164.19	5.710	145.03
M40DSK_	40	6.084	154.53	6.406	162.71	6.525	165.74	6.838	173.69	7.088	180.04	6.334	160.88
M43DSK_	43	6.552	166.42	6.874	174.60	6.993	177.62	7.306	185.57	7.556	191.92	6.802	172.77
M47DSK_	47	7.176	182.27	7.498	190.45	7.617	193.47	7.930	201.42	8.180	207.77	7.426	188.62
M50DSK_	50	7.644	194.16	7.966	202.34	8.085	205.36	8.398	213.31	8.648	219.66	7.894	200.51

PART NUMBER CODING

M _ _ DSK _-S_ :

MATERIAL (INSULATOR/CONTACT)

E = PBT/PHOSPHOR BRONZE

OPERATING TEMP: -65°C TO +125°C

PROCESSING TEMP: WAVE/MANUAL SOLDERING ONLY

R = PPS/PHOSPHOR BRONZE

OPERATING TEMP: -65°C TO +125°C

PROCESSING TEMP: 260°C MAX FOR 20 SECONDS

G = PA9T/PHOSPHOR BRONZE

OPERATING TEMP: -65°C TO +125°C

PROCESSING TEMP: 260°C MAX FOR 20 SECONDS

H = PBT/BERYLLIUM COPPER

OPERATING TEMP: -65°C TO +125°C

PROCESSING TEMP: WAVE/MANUAL SOLDERING ONLY

A = PPS/BERYLLIUM COPPER

OPERATING TEMP: -65°C TO +150°C

PROCESSING TEMP: 260°C MAX FOR 20 SECONDS

J = PA9T/BERYLLIUM COPPER

OPERATING TEMP: -65°C TO +150°C

PROCESSING TEMP: 260°C MAX FOR 20 SECONDS

(CONSULT FACTORY FOR OTHER MATERIALS)

↑ ↑ MODIFICATION CODE

- OMIT FOR STANDARD, EX: 'EBM22DSKH'
- S38 = BLACK PBT (MATERIAL CODES E AND H ONLY)
- S81 = GREEN PBT (MATERIAL CODES E AND H ONLY)
- S328 = BROWN PPS (MATERIAL CODES R AND A ONLY)

- MOUNTING STYLE

H = .125 DIA. CLEARANCE HOLES

I = #4-40 THREADED INSERT

S = .125 DIA. SIDE MOUNTING

N = NO MOUNTING EARS

B = OPEN CARD SLOT

- NUMBER OF POSITIONS

(CONTACTS PER ROW)

-PLATING

6

ALL PLATINGS HAVE .000050" NICKEL UNDERPLATE

CONTACT SURFACE TERMINATION

G = .000010" GOLD .000005" GOLD

Y = .000030" GOLD .000005" GOLD

B = .000010" GOLD .000100" PURE TIN, MATTE

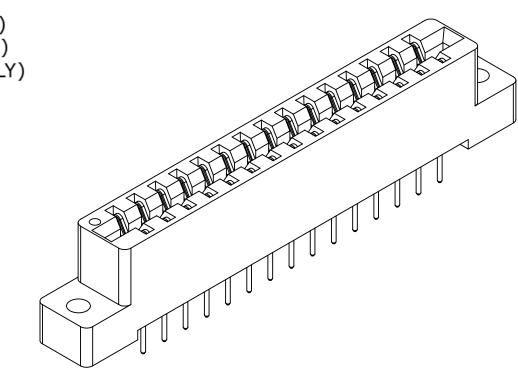
C = .000030" GOLD .000100" PURE TIN, MATTE

**E = .000100" PURE TIN, MATTE, OVERALL

S = .000010" GOLD OVERALL

M = .000030" GOLD .000010" GOLD OVERALL

** OVERALL TIN ONLY AVAILABLE ON MATERIAL CODES E, R AND G



CUSTOMER COPY



UNLESS OTHERWISE SPECIFIED:	DRAWN	DATE	NAME		
DIMENSIONS ARE IN INCHES [MM]		1/16/2014	JHSU		
TOLERANCES:	ONTAINS ON OF	TITLE			
ANGULAR: ± 1°	SULLINS EL TO BE RE DISCLOSE				
DECIMALS .XX=± .02 [.5]	PURPOSE E AUTHORI OFFICER OF	PART	NUME		
.XXX=± .005 [.13] .XXXX=± .0005 [.013]			$\overline{}$	SIZE	CAC
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	I(Y)		.		C. 0.4

NAME
JHSU
CONTAINS
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BY AN
IFRONICS.

SIZE CAGE CODE DWG. NO.
C 54453
SCALE: 2:1

SHEET 3 OF 3

FILE NAME: C12337, _ _M_ _DSK_-(OMIT, \$38, \$81, \$328)